

05-05-2000

EPCOP0101USA

To the Honorable Commissioner of Patents and Trade

101347222

all documents or copy thereof.

## 1. Name of conveying party(ies):

Hatsuo Ishida

Additional name(s) of conveying

party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

☒ Assignment ☐ Merger☐ Security Agreement ☐ Change of Name☐ Other \_\_\_\_\_

Execution Date: April 4, 2000

## 2. Name and address of receiving party(ies):

Name: Edison Polymer Innovation Corporation

Internal Address: \_\_\_\_\_

Street Address: 4040 Embassy Parkway, Suite 150

City: Akron

State/Country: Ohio ZIP: 44333

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_

A. Patent Application No.(s)

09/442,200

B. Patent No.(s)

Additional Numbers attached? ☐ Yes ☒ No5. Name and address of party to whom  
correspondence concerning document  
should be mailed:

Name: Renner, Otto, Boisselle &amp; Sklar, LLP

Internal Address: \_\_\_\_\_

Street Address: 1621 Euclid Avenue, 19th Floor

City: Cleveland

State: Ohio ZIP: 44115

## 6. Total number of applications and patents involved: [ 1 ]

7. Total fee (37 CFR 3.41) .....\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William C. Tritt

Name of Person Signing

Signature

Date

Reg. No. 32,510 Total number of pages including cover sheet attachments, and document: [ 2 ]

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231PATENT  
REEL: 010752 FRAME: 0990

# ASSIGNMENT

For One Dollar (\$1.00) and other good and valuable consideration received of the hereinafter named assignee, receipt of which is hereby acknowledged, I the undersigned

of

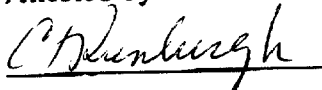
Hatsuo Ishida  
2903 Weybridge Road  
Shaker Heights, Ohio 44120

hereby sell and assign to Edison Polymer Innovation Corporation  
a corporation of Ohio having a place  
of business at 4040 Embassy Parkway, Suite 150, Akron, Ohio 44333 its  
successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and  
Possessions thereof and all foreign countries, in and to the inventions in

## POLYBENZOXAZINE NANOCOMPOSITES OF CLAY AND METHOD FOR MAKING SAME

set forth in the application for United States Letters Patent executed by the undersigned on the dates indicated below, said application for United States Letters Patent, any and all other applications for Letters Patent on said inventions in countries foreign to the United States, including all divisional, renewal, substitute, continuation and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues and extensions of Letters Patent granted for said inventions or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said applications and said Letters Patent; said assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said assignee or otherwise as said assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents of the United States of America and the empowered officials of all other governments being hereby authorized to issue or transfer all said Letters Patent to said assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right heretofore given, and that the undersigned will do all acts reasonably serving to assure that the said inventions, patent applications and Letters Patent shall be held and enjoyed by said assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

Attested by:



Signed:

  
Hatsuo Ishida

Dated:

4-4-00